



4209106-2/M 04/16

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. PicoStar™ package configuration.
 - $\triangle D$ The package size (Dimension D and E) of a particular device is specified in the device Product Data Sheet version of this drawing, in case it cannot be found in the product data sheet please contact a local TI representative.
 - $\triangle E$ Reference Product Data Sheet for array population. 2 x 2 matrix pattern is shown for illustration only.
 - F. This package is a Pb-free solder land design.

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